

1A, 200V - 600V Surface Mount Super Fast Rectifier

FEATURES

- Glass passivated junction chip
- Ideal for automated placement
- Super fast recovery time for high efficiency
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

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- Switching mode power supply (SMPS)
- Adapters
- Lighting application
- Converter

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- Case: DO-214AC (SMA)
- Molding compound meets UL 94V-0 flammability rating
- Moisture sensitivity level: level 1, per J-STD-020
- Packing code with suffix "G" means green compound (halogen-free)
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 1A whisker test
- Polarity: As marked
- Weight: 0.06 g (approximately)

KEY PARAMETERS						
PARAMETER	VALUE	UNIT				
I _{F(AV)}	1	А				
V_{RRM}	200 - 600	>				
I _{FSM}	30	Α				
T _{J MAX}	150	°C				
Package	DO-214AC (SMA)					
Configuration	Single Die)				





DO-214AC (SMA)

PARAMETER	SYMBOL	ES1D-T	ES1G-T	ES1J-T	UNIT
Marking code on the device		ES1D	ES1G	ES1J	
Repetitive peak reverse voltage	V_{RRM}	200	400	600	V
Reverse voltage, total rms value	V _{R(RMS)}	140	280	420	V
Maximum DC blocking voltage	V _{DC}	200	400	600	V
Forward current	I _{F(AV)}		1		Α
Surge peak forward current, 8.3 ms single half sine-wave superimposed on rated load per diode)	I _{FSM}		30		А
Junction temperature	TJ	- 55 to +150			
Storage temperature	T _{STG}	- 55 to +150			



THERMAL PERFORMANCE							
PARAMETER	SYMBOL	TYP	UNIT				
Junction-to-ambient thermal resistance	$R_{\Theta JA}$	85	°C/W				
Junction-to-lead thermal resistance	$R_{\Theta JL}$	35	°C/W				

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)						
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT	
	ES1D-T		V _F	-	0.95	V
Forward voltage per diode (1)	ES1G-T	I _F =1A, T _J =25°C		-	1.30	٧
	ES1J-T			-	1.70	V
Develope a compant @ material // man diede (2)	T _J = 25°C		-	5	μΑ	
Reverse current @ rated V _R per diode ⁽²⁾		T _J =125°C	I _R	-	100	μΑ
	ES1D-T			16	-	pF
Junction capacitance ES1G-T ES1J-T		1 MHz, V _R =4.0V	1 MHz, V _R =4.0V C _J	18		pF
				10	-	рг
Reverse recovery time	I _F =0.5A , I _R =1.0A I _{RR} =0.25A	t _{rr}	-	35	ns	

Notes:

- Pulse test with PW=0.3 ms
- Pulse test with PW=30 ms

ORDERING INFORMATION						
PART NO.	PACKING CODE	PACKING CODE SUFFIX	PACKAGE	PACKING		
	R3		SMA	1,800 / 7" Plastic reel		
ES1x-T (Note 1, 2)	R2	G	SMA	7,500 / 13" Paper reel		
	M2		SMA	7,500 / 13" Plastic reel		

Notes:

- 1. "x" defines voltage from 200V (ES1D-T) to 600V (ES1J-T)
- Whole series with green compound (halogen-free)

EXAMPLE P/N							
EXAMPLE P/N	PART NO.	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION			
ES1J-T R3G	ES1J-T	R3	G	Green compound			



CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

Fig1. Forward Current Derating Curve

1.2 AVERAGE FORWARD CURRENT (A) 1 8.0 0.6 0.4 0.2 Resister or inductive load 0 80 90 100 110 120 130 140 150 LEAD TEMPERATURE (°C)

Fig2. Typical Junction Capacitance

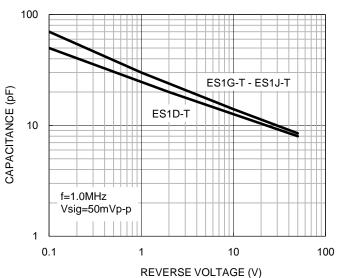


Fig3. Typical Reverse Characteristics

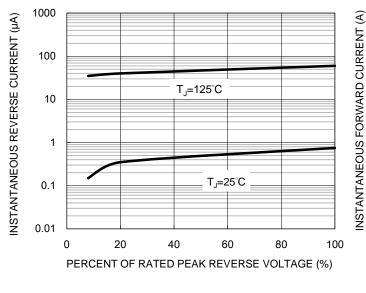
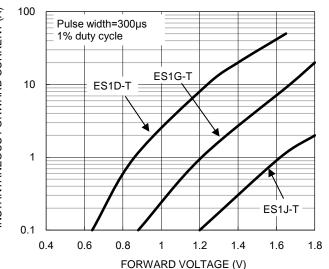


Fig4. Typical Forward Characteristics



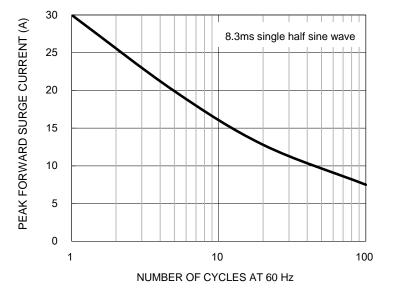
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CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig5. Maximum Non-repetitive Forward Surge Current



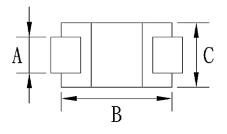
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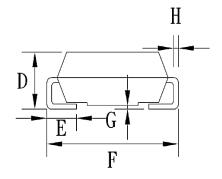




PACKAGE OUTLINE DIMENSIONS

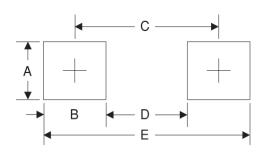
DO-214AC (SMA)





DIM	Unit	(mm)	Unit ((inch)
	Min	Max	Min	Max
Α	1.27	1.58	0.050	0.062
В	4.06	4.60	0.160	0.181
С	2.29	2.83	0.090	0.111
D	1.99	2.50	0.078	0.098
E	0.90	1.41	0.035	0.056
F	4.95	5.33	0.195	0.210
G	0.10	0.20	0.004	0.008
Н	0.15	0.31	0.006	0.012

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
Α	1.68	0.066
В	1.52	0.060
С	3.93	0.155
D	2.41	0.095
Е	5.45	0.215

MARKING DIAGRAM



P/N = Marking Code
G = Green Compound
YW = Date Code
F = Factory Code



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